

Data sheet acquired from Harris Semiconductor SCHS080C – Revised July 2003

CMOS BCD Rate Multiplier

High-Voltage Types (20-Volt Rating)

a CD4527B is a low-power 4-bit digital rate multiplier that provides an output-pulse rate which is the clock-input-pulse rate multiplied by 1/10 times the BCD input. For example, when the BCD input is 8, there will be 8 output pulses for every 10 input pulses. This device may be used to perform arithmetic operations (add, subtract, divide, raise to a power), solve algebraic and differential equations, generate natural logarithms and trigonometric functions, A/D and D/A conversion, and frequency division.

For fractional multipliers with more than one digit, CD4527B devices may be cascaded in two different modes: the Add mode and the Multiply mode. (See Figs.12 and 15). In the Add mode,

In the Multiply mode, the fraction programmed into the first rate multiplier is multiplied by the fraction programmed into the second one,

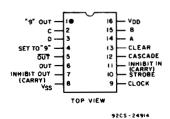
e.g.
$$\frac{9}{10} \times \frac{4}{10} = \frac{36}{100}$$
 or 36 output

pulses for every 100 clock input pulses.

The CD4527B types are supplied in 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Applications:

- Numerical control
- Instrumentation
- Digital filtering
- **■** Frequency synthesis



TERMINAL ASSIGNMENT

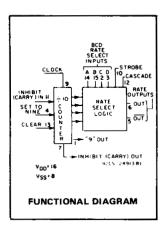
CD4527B Types

Features:

- Cascadable in multiples of 4-bits
- Set to "9" input and "9" detect output
- = 100% test for quiescent current at 20 V
- = 5-V, 10-V, and 15-V parametric ratings
- Standardized, symmetrical output characteristics.
- Maximum input current of 1 µA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range) =

1 V at V_{DD} ≠ 5 V 2 V at V_{DD} = 10 V 2.5 ∀ at V_{DD} = 1.5 V

 Meets all requirements of JEDEC Tentative Standard No. 13B, Standard Specifications for Description of 'B' Series CMOS Devices"



MAXIMUM RATINGS, Absolute-Maximum Values:

	DC SUPPLY-VOLTAGE RANGE, (V _{DD})
0.5V to +20V	Voltages referenced to VSS Terminal)
0.5V to V _{DD} +0.5V	INPUT VOLTAGE RANGE, ALL INPUTS
±10mA	DC INPUT CURRENT, ANY ONE INPUT
(P _D):	POWER DISSIPATION PER PACKAGE (F
500mW	For $T_A = -55^{\circ}C$ to $+100^{\circ}C$
Derate Linearity at 12mW/°C to 200mW	For TA = +100°C to +125°C
	DEVICE DISSIPATION PER OUTPUT TRA
ATURE RANGE (All Package Types) 100mW	FOR TA = FULL PACKAGE-TEMPERA
(T _A)55°C to +125°C	OPERATING-TEMPERATURE RANGE (T
tg)65°C to +150°C	
	LEAD TEMPERATURE (DURING SOLDE
0.79mm) from case for 10s max +265°C	At distance $1/16 \pm 1/32$ inch (1.59 ± 0.7)

RECOMMENDED OPERATING CONDITIONS AT $T_A = 25^{\circ}C$, Except as Noted. For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CUA DA OTERIOTIO	V _{DD}	LIN	LIMITS		
CHARACTERISTIC	(V)	Min.	Max.	UNITS	
Supply Voltage Range (For TA = Full Package Temperature Range)		3	18	٧	
Set or Clear Pulse Width, tw	5 10 15	160 90 60	+	ns	
Clock Pulse Width, t _W	5 10 15	330 170 100		ns	
Clock Frequency, fCL	5 10 15	dc	1.2 2.5 3.5	MHz	
Clock Rise or Fall Time, trCL or tfCL	5,10,15	_	15	μs	
Inhibit In Setup Time, tSU	5 10 15	100 40 20	- - -	ns	
Inhibit In Removal Time, tREM	5 10 15	240 130 110	_ _ _	ns	
Set Removal Time, tREM	5 10 15	150 80 50	_ _ _	ns	
Clear Removal Time, t _{REM}	5 10 15	60 40 30	- - -	ns	

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CD4527B Types

STATIC ELECTRICAL CHARACTERISTICS

CHARACTER-	CONE	NDITIONS LIMITS AT INDICATED TEMPERATUR						TURES	UNITS		
ISTIC	vo	VIN	v_{DD}						+25		ONT
	(V)	(V)	(V)	-55	-40	+85	+125	Min.	Тур.	Max.	
Quiescent Device	-	0,5	5	5	5	150	150	-	0.04	5	
Current,		0,10	10	10	10	300	300		0.04	10	μΑ
IDD Max.		0,15	15	20	20	600	600	- :	0.04	20	"^
	_	0,20	20	100	100	3000	3000	-	0.08	100	
Output Low	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	-	
(Sink) Current	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	-	1
IOL Min.	1.5	0,15	15	4.2 4 2.8 2.4 34 6.8 -	-	1					
Output High (Source) Current, IOH Min.	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	1	_	mA
	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	-	
	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6		
	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	6.8	-	
Output Voltage:	-	0,5	5		0	.05		-	0	0.05	
Low-Level, VOL Max.	-	0,10	10		0	.05		-	0	0.05	. 1
AOF Max.	-	0,15	15		ō	.05		-	-0	0.05	. _V
Output Voltage:		0,5	5	4.95				4.95	5	-	
High-Level,		0,10	10		9	.95		9.95	-10	-	
VOH Min.		0,15	15		14	1.95		14.95	15	_	
Input Low	0.5, 4.5	_	5		1	.5		-		1.5	
Voltage,	1, 9	_	10			3	-	-	_	3	
VIL Max.	1.5, 13.5	_	15			4			_	4	
Input High	0.5, 4.5	_	5		3	3.5		3.5	_	-	٧
Voltage,	1, 9	_	10		7					1	
VIH Min.	1.5,13,5	_	15		•	11		11		_	
Input Current IIN Max.		0,18	18	±0.1	±0.1	±1	±1	-	±10-5	±0.1	μА

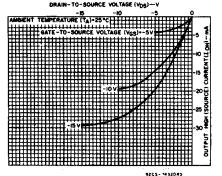


Fig.3 — Typical output high (source) current characteristics.

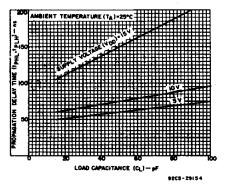


Fig.6 — Typical propagation delay time as a function of load capacitance (Clock or Strobe to Out).

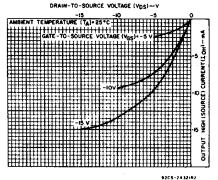


Fig.4 - Minimum output high (source) current characteristics.

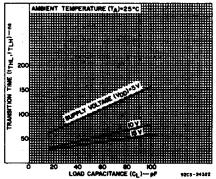


Fig.7 — Typical transition time as a function of load capacitance.

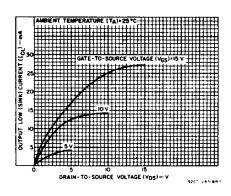


Fig. 1 — Typical output low (sink) current characteristics.

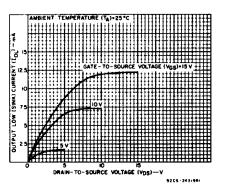


Fig.2 – Minimum output low (sink) current characteristics.

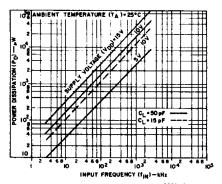


Fig.5 — Typical dynamic power dissipation as a function of input frequency.

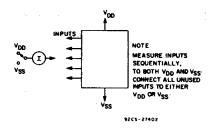


Fig.8 - Input current test circuit.

CD4527B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at T $_{A}$ = 25°C: Input t, tf = 20 ns, C $_{L}$ = 50 pF, R $_{L}$ = 200 k Ω

	TEST COND	PITIONS	<u> </u>	LIMITS	<u> </u>	<u> </u>
CHARACTERISTIC		V _{DD} (V)	Min.	Тур.	Max.	UNITS
Brancastica Dalau Tima tauru anu		5	_	110	220	
Propagation Delay Time, tPHL, tPLH Clock to Out		10	- 1	55	110	
Clock to Out		15	-	45	90	20
		5	_	150	300	ns
Clock or Strobe to Out		10	-	75	150	
		15	_	60	120	
Clock to Inhibit Out		5	· -	320	640	
High Level to Low Level		10	-	145	290	
		15	_	100	200	ns
		5	-	250	500	l ''3
Low Level to High Level	į	10		100	200	
	ļ	15		75	150	
		5	- :	380	760	
Clear to Out		10	-	175	350	
		15	-	130	260	ns
01 1 100 1151 0		5	- '	300	600	,,,,
Clock to "9" or "15" Out		10	-	125	250	
		15		90	180	
		5	- 1	90	180	
Cascade to Out	l .	10	-	45	90	
•		15		35	70	ns
11991 - 1499 - 0		5	-	130	260	
Inhibit In to Inhibit Out		10	_	60	120	
	-	15		45	90	
S-1 1- 10-14	•	5	-	330	660	
Set to Out	İ	10	_	150	300	
		15		110	220	ns
Transition Time to to	•	5	-	100	200	
Transition Time, tTHL, tTLH	1	10 15	-	50 40	100 80	
		5	10			
Maximum Clock Frequency, fCL]	10	1.2 2.5	2.4 5	_	MHz
Maximum Glock 1 reduction, ICE	•	15	3.5	7		1411.32
· · · · · · · · · · · · · · · · · · ·	 	5		165	330	
Minimum Clock Pulse Width, tw		10	_	85	170	ns
, , , , , , , , , , , , , , , , , , , 	1	15	1	50	100	
	Ţ	5			15	
Clock Rise or Fall Time, trCL, tfCL		10	_		15	μs
.00 102	<u> </u>	15			15	
		5	_	80	160	
Minimum Set or Clear Pulse Width, tw		10	-	45	90	
		15	-	30	60	ns
		5	-	50	100	113
Minimum Inhibit In Setup Time, t _{SU}		10	-	20	40	
		15	-	10	20	
Minimum Inhibit In Removal Time,		.5	_	120	240	
tREM		10	-	65	130	
, , Livi		15		55	110	ns
Minimum Cox Dox 1 T		5	-	75	150	···-
Minimum Set Removal Time, tREM		10	-	40	80	
	ļ	15		25	50	
Minimum Olean Danson A.T		5	-	30	60	
Minimum Clear Removal Time, TREM]	10 15	_	20 15	40 30	ris .
Input Canaditanes Con-	Any Inne	13	\vdash			
Input Capacitance, CIN	Any Input		-	5	7.5	pF

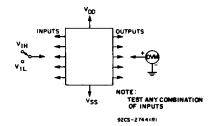


Fig.9 - Input voltage test circuit.

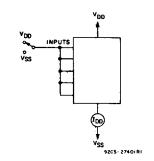


Fig. 10 -Quiescent device current test circuit.

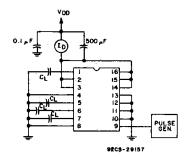


Fig. 11 - Dynamic power dissipation test circuit.

APPLICATIONS

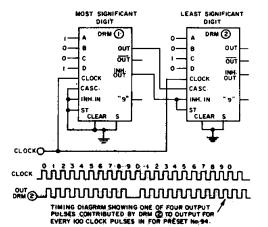


Fig.12 - Two CD45278's cascaded in the "Add" mode with a preset number

of 94
$$\left(\frac{9}{10} + \frac{4}{100} = \frac{94}{100}\right)$$
.

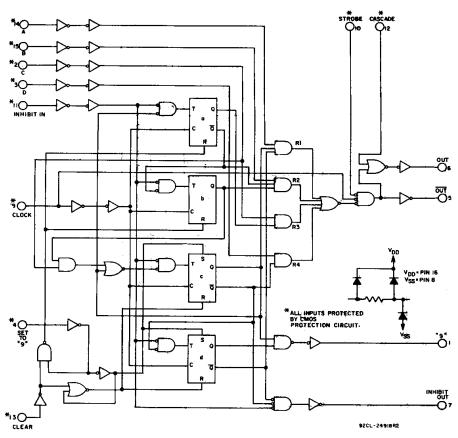
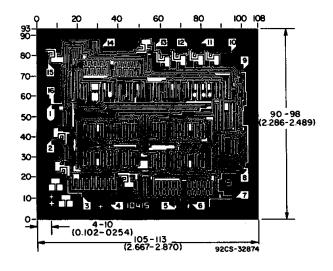


Fig. 13 — Logic diagram.



Dimensions and Pad Layout for CD4527BH

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

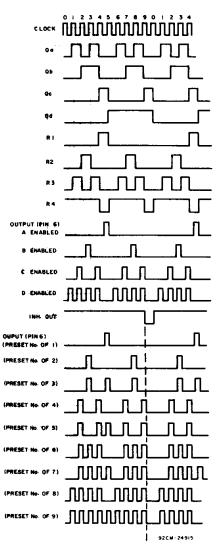


Fig. 14 - Timing diagram (See Logic Diagram).

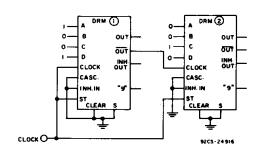


Fig. 15 — Two CD4527B's cascaded in the "Multiply" mode with a preset number of $36\left(\frac{9}{10}\times\frac{4}{10}=\frac{36}{100}\right)$.

CD4527B Types

TRUTH TABLE

	INPUTS									Γ'''	OUTPL	JTS	
	Number of Pulses or Input Logic Level (0 = Low; 1 = High; X = Don't Care)									0	umber of utput Log	Pulses o)
D									OUT	OUT	INH	"9" OUT	
0	0.	o	0	10	0	0	0	0	0	L	Н	1	1
0	0	0	1	10	0	0	0	0	0	1	1	1	1
0	0	1	0	10	0	0	0	0	0	2	2	1 1	1
0	0	1	1	10	0	0	0	0	0	3	3	1	1
0	1	0	Q	10	0	0	0	0	0	4	4	1	1
0	1	0	1	10	0	0	0	0	0	5	5	1 1	1
0	1	1	0	10	0	0	0	0	0	6	6	1	1 1
0	1	1	1	10	0	0	0	0	0	7	7	1	1
1	0	0	0	10	0	0	0	0	0	8	8	1	1
1	0	0	1	10	0	0	0	0	0	9	9	1	1
1	0	1	0	10	0	-0	0	O	0	8	8	1	1
1	0	1	1	10	0	0	Ö	0	0	9	9	1	1
1	1	0	0	10	0	0	0	0	0	8	8	1	1
1	1	0	1	10	0	0	0	0	0	9	9	1	1
1	1	1	0	10	0	0	0	0	0	8	8	1	1
1	1	1	1	10	0	0	0	0	0	9	9	1	1
x	X	х	x	10	1	0	0	0	0	†	†	н	+
x		x	x	10	o	1	0	o	0	Ĺ	н	1	' ,
X	X		х	10	ō	Ö	1	0	o ·	H	*	i	i
1	х	x	X	10	0	0	0	1	0	10	10	Н	L
0	Х	X	X	10	0	0	0	1	0	L	H	н	ŭ
X	X	X	х	10	0	0	0	0	1	L	н	L	н

^{*} Output same as the first 16 lines of this truth table (depending on values of A, B, C, D).

†Depends on internal state of counter.

[#]Clear and Set Inputs should not be high at the same time; device draws increased quiescent current when in this non-valid state.





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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CD4527BE	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4527BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4527BPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4527BPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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Mailing Address: Texas Instruments

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